imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



ne<mark>x</mark>peria

Important notice

Dear Customer,

On 7 February 2017 the former NXP Standard Product business became a new company with the tradename **Nexperia**. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of <u>http://www.nxp.com</u>, <u>http://www.philips.com/</u> or <u>http://www.semiconductors.philips.com/</u>, use <u>http://www.nexperia.com</u>

Instead of sales.addresses@www.nxp.com or sales.addresses@www.semiconductors.philips.com, use **salesaddresses@nexperia.com** (email)

Replace the copyright notice at the bottom of each page or elsewhere in the document, depending on the version, as shown below:

- © NXP N.V. (year). All rights reserved or © Koninklijke Philips Electronics N.V. (year). All rights reserved

Should be replaced with:

- © Nexperia B.V. (year). All rights reserved.

If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

Octal D-type flip-flop with reset; positive-edge triggerRev. 1 — 19 June 2013Product data sheet

1. General description

The 74HC273-Q100; 74HCT273-Q100 is an octal positive-edge triggered D-type flip-flop. The device features clock (CP) and master reset ($\overline{\text{MR}}$) inputs. The outputs Qn assume the state of their corresponding Dn inputs that meet the set-up and hold time requirements on the LOW-to-HIGH clock (CP) transition. A LOW on $\overline{\text{MR}}$ forces the outputs LOW independently of clock and data inputs. Inputs include clamp diodes which enable the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Input levels:
 - For 74HC273-Q100: CMOS level
 - For 74HCT273-Q100: TTL level
- Common clock and master reset
- Eight positive edge-triggered D-type flip-flops
- Complies with JEDEC standard no. 7A
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V.
- Multiple package options

3. Ordering information

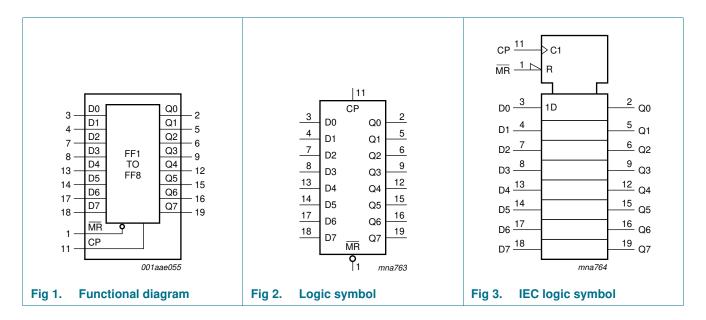
Table 1. Ordering information

Type number	Package									
	Temperature range	Name	Description	Version						
74HC273D-Q100	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width							
74HCT273D-Q100			7.5 mm							
74HC273PW-Q100	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads;	SOT360-1						
74HCT273PW-Q100			body width 4.4 mm							
74HC273BQ-Q100	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced	SOT764-1						
74HCT273BQ-Q100			very thin quad flat package; no leads; 20 terminals; body $2.5\times4.5\times0.85~\text{mm}$							

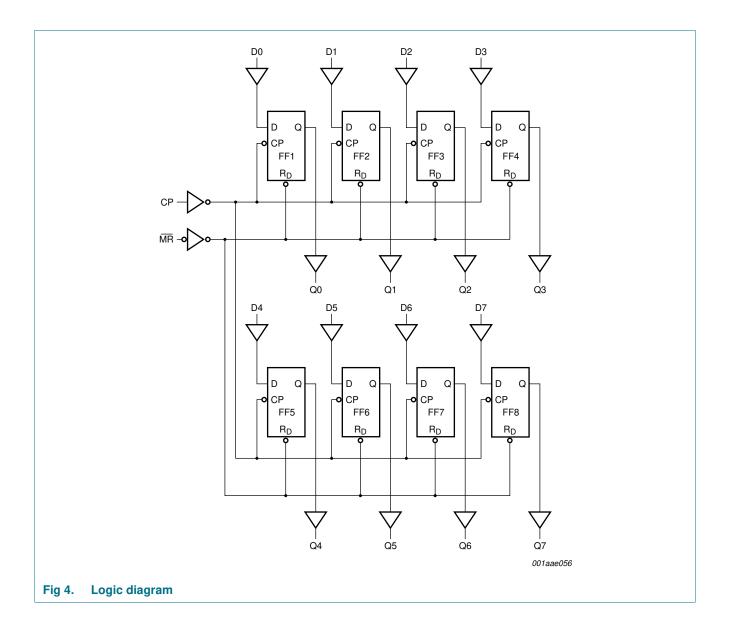


Octal D-type flip-flop with reset; positive-edge trigger

4. Functional diagram



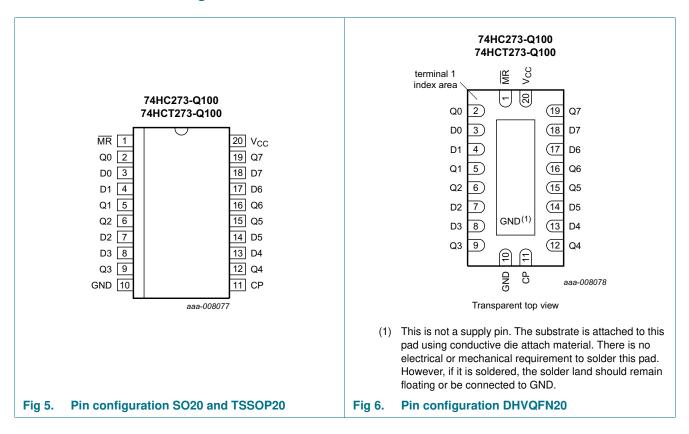
Octal D-type flip-flop with reset; positive-edge trigger



Octal D-type flip-flop with reset; positive-edge trigger

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description		
Symbol	Pin	Description
MR	1	master reset input (active LOW)
Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7	2, 5, 6, 9, 12, 15, 16, 19	flip-flop output
D0, D1, D2, D3, D4, D5, D6, D7	3, 4, 7, 8, 13, 14, 17, 18	data input
GND	10	ground (0 V)
СР	11	clock input (LOW-to-HIGH, edge-triggered)
V _{CC}	20	supply voltage

Octal D-type flip-flop with reset; positive-edge trigger

6. Functional description

Table 3.Function table^[1]

Operating modes	Inputs	Outputs		
	MR	Dn	Qn	
reset (clear)	L	Х	Х	L
load "1"	Н	↑	h	Н
load "0"	Н	↑	l	L

[1] H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition;

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition;

X = don't care;

 \uparrow = LOW-to-HIGH clock transition.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V)

					,
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7	V
I _{IK}	input clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm CC}$ + 0.5 V	[1] -	±20	mA
I _{OK}	output clamping current	$V_O < -0.5$ V or $V_O > V_{CC}$ + 0.5 V	[1] -	±20	mA
l _O	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	-	±25	mA
I _{CC}	supply current		-	50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	[2] _	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SO20 package: above 70 °C the value of P_{tot} derates linearly with 8 mW/K. For TSSOP20 package: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K. For DHVQFN20 package: P_{tot} derates linearly with 4.5 mW/K above 60 °C.

Octal D-type flip-flop with reset; positive-edge trigger

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	l Parameter Conditions		74HC273-Q100			74HCT273-Q100			Unit
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V_{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	-	+125	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC27	3-Q100									
V _{IH}	HIGH-level	$V_{CC} = 2.0 V$	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	$V_{CC} = 4.5 V$	3.15	2.4	-	3.15	-	3.15	-	V
		$V_{CC} = 6.0 V$	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	$V_{CC} = 4.5 V$	-	2.1	1.35	-	1.35	-	1.35	V
	$V_{CC} = 6.0 V$	-	2.8	1.8	-	1.8	-	1.8	V	
V _{OH} HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$									
	output voltage	I_O = –20 $\mu A;V_{CC}$ = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I_O = –20 $\mu A;V_{CC}$ = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I_O = –20 $\mu A;V_{CC}$ = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I_{O} = -4.0 mA; V_{CC} = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I_{O} = –5.2 mA; V_{CC} = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_I = V_{IH} \text{ or } V_{IL}$								
	output voltage	I_O = 20 $\mu A; V_{CC}$ = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		$I_O=20~\mu\text{A};V_{CC}=4.5~\text{V}$	-	0	0.1	-	0.1	-	0.1	V
		$I_O=20~\mu\text{A};V_{CC}=6.0~V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	-	0.33	-	0.4	V
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
lı	input leakage current		-	-	±0.1	-	±1	-	±1	μ A
I _{CC}	supply current		-	-	8.0	-	80	-	160	μ A

Octal D-type flip-flop with reset; positive-edge trigger

Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
CI	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT2	73-Q100									
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{ОН}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -4.0 \text{ mA}$	3.98	4.32	-	3.84	-	3.7	-	V
V _{OL} I	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	$I_O=20~\mu\text{A};V_{CC}=4.5~\text{V}$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 5.5 \text{ V}$	-	0.15	0.26	-	0.33	-	0.4	V
I	input leakage current	$V_1 = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±0.1	-	±1	-	±1	μA
I _{CC}	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} \text{ or } GND; \ I_{O} = 0 \ \text{A}; \\ V_{CC} = 5.5 \ \text{V} \end{array}$	-	-	8.0	-	80	-	160	μA
∆l _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1 V$; other inputs at V_{CC} or GND; $V_{CC} = 4.5 V$ to 5.5 V								
		MR input	-	100	360	-	450	-	490	μA
		CP input	-	175	630	-	787.5	-	857.5	μA
		Dn input	-	15	54	-	67.5	-	73.5	μA
CI	input capacitance		-	3.5	-	-	-	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit, see <u>Figure 10</u>

Symbol Parameter		Conditions		25 °C		–40 °C to +85 °C		–40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC27	73-Q100									
t _{pd}	propagation	CP to Qn; see Figure 7								
	delay	$V_{CC} = 2.0 V$	-	41	150	-	185	-	225	ns
		$V_{CC} = 4.5 V$	-	15	30	-	37	-	45	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	15	-	-	-	-	-	ns
		$V_{CC} = 6.0 V$	-	13	26	-	31	-	38	ns

Octal D-type flip-flop with reset; positive-edge trigger

Symbol	Parameter	Conditions		25 °C		_40 °C	to +85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
^I PHL	HIGH to LOW	MR to Qn; see Figure 8								
	propagation	$V_{CC} = 2.0 V$	-	44	150	-	185	-	225	ns
	delay	V _{CC} = 4.5 V	-	16	30	-	37	-	45	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	15	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	14	26	-	31	-	38	ns
·t	transition time	Qn output; see Figure 7	1							
		V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V _{CC} = 6.0 V	-	6	13	-	15	-	19	ns
tw	w pulse width	CP input HIGH or LOW; see Figure 7								
		$V_{CC} = 2.0 V$	80	14	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	5	-	20	-	24	-	ns
		$V_{\rm CC} = 6.0 \rm V$	14	4	-	17	-	20	-	ns
		MR input LOW; see Figure 8								
		$V_{CC} = 2.0 V$	60	17	-	75	-	90	-	ns
		V _{CC} = 4.5 V	12	6	-	15	-	18	-	ns
		V _{CC} = 6.0 V	10	5	-	13	-	15	-	ns
rec	recovery time	MR to CP; see Figure 8								
		V _{CC} = 2.0 V	50	-6	-	65	-	75	-	ns
		V _{CC} = 4.5 V	10	-2	-	13	-	15	-	ns
		$V_{CC} = 6.0 V$	9	-2	-	11	-	13	-	ns
su	set-up time	Dn to CP; see Figure 9								
		V _{CC} = 2.0 V	60	11	-	75	-	90	-	ns
		V _{CC} = 4.5 V	12	4	-	15	-	18	-	ns
		$V_{CC} = 6.0 V$	10	3	-	13	-	15	-	ns
h	hold time	Dn to CP; see Figure 9								
		$V_{CC} = 2.0 V$	3	-6	-	3	-	3	-	ns
		V _{CC} = 4.5 V	3	-2	-	3	-	3	-	ns
		$V_{CC} = 6.0 V$	3	-2	-	3	-	3	-	ns
max	maximum	CP input; see Figure 7								
	frequency	$V_{CC} = 2.0 V$	6	20.6	-	4.8	-	4	-	MH:
		$V_{CC} = 4.5 V$	30	103	-	24	-	20	-	MHz
		V _{CC} = 5.0 V; C _L = 15 pF	-	66	-	-	-	-	-	MHz
		$V_{CC} = 6.0 V$	35	122	-	28	-	24	-	MHz
C _{PD}	power dissipation	per package; I_{I}^{3} V _I = GND to V _{CC}		20	-	-	-	-	-	pF

Table 7. Dynamic characteristics ... continued

74HC_HCT273_Q100 **Product data sheet**

Octal D-type flip-flop with reset; positive-edge trigger

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HCT27	73-Q100					I	I	1		
t _{pd}	propagation	CP to Qn; see Figure 7	1							
	delay	$V_{CC} = 4.5 V$	-	16	30	-	38	-	45	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	15	-	-	-	-	-	ns
t _{PHL}	HIGH to LOW	MR to Qn; see Figure 8								
	propagation	$V_{CC} = 4.5 V$	-	23	34	-	43	-	51	ns
	delay	$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	20	-	-	-	-	-	ns
t _t	transition time	Qn output; see Figure 7	1							
		$V_{CC} = 4.5 V$	-	7	15	-	19	-	22	ns
tw	pulse width	CP input; see Figure 7								
		$V_{CC} = 4.5 V$	16	9	-	20	-	24	-	ns
		MR input LOW; see <u>Figure 8</u>								
		$V_{CC} = 4.5 V$	16	8	-	20	-	24	-	ns
t _{rec}	recovery time	MR to CP; see Figure 8								
		$V_{CC} = 4.5 V$	10	-2	-	13	-	15	-	ns
t _{su}	set-up time	Dn to CP; see Figure 9								
		$V_{CC} = 4.5 V$	12	5	-	15	-	18	-	ns
t _h	hold time	Dn to CP; see Figure 9								
		$V_{CC} = 4.5 V$	3	-4	-	3	-	3	-	ns
f _{max}	maximum	CP input; see Figure 7								
	frequency	$V_{CC} = 4.5 V$	30	56	-	24	-	20	-	MHz
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	36	-	-	-	-	-	MHz
C _{PD}	power dissipation capacitance	per package; $\underline{I3}$ V _I = GND to V _{CC} - 1.5 V	<u>l</u> –	23	-	-	-	-	-	pF

Table 7. Dynamic characteristics ... continued

GND (ground = 0 V); C_1 = 50 pF unless otherwise specified; for test circuit, see Figure 10

[1] t_{pd} is the same as t_{PHL} and t_{PLH} .

 $\label{eq:ttilde} [2] \quad t_t \text{ is the same as } t_{THL} \text{ and } t_{TLH}.$

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} + \Sigma \ (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 $f_i = input frequency in MHz;$

 f_o = output frequency in MHz;

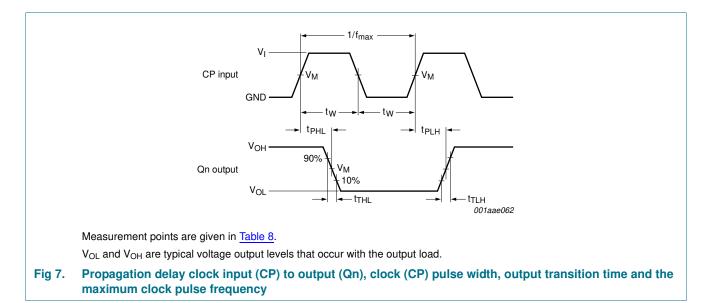
 $\Sigma (C_L \times V_{CC}^2 \times f_o)$ = sum of outputs;

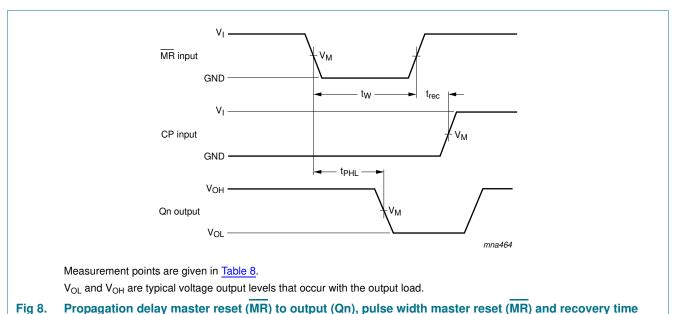
 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V.

Octal D-type flip-flop with reset; positive-edge trigger

11. Waveforms





master reset (MR) to clock (CP)

Octal D-type flip-flop with reset; positive-edge trigger

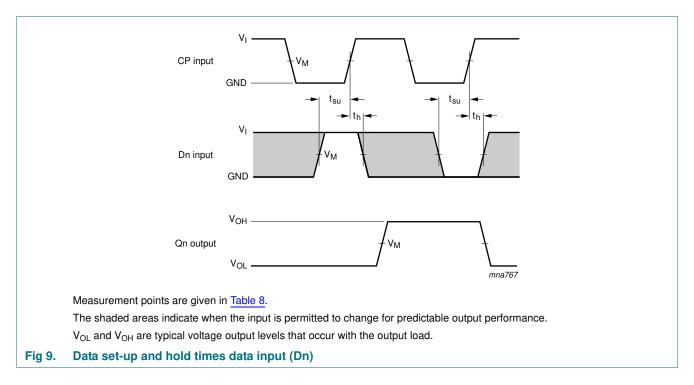


Table 8.Measurement points

Туре	Input	Output	
	VI	V _M	V _M
74HC273-Q100	V _{CC}	0.5V _{CC}	0.5V _{CC}
74HCT273-Q100	3 V	1.3 V	1.3 V

Octal D-type flip-flop with reset; positive-edge trigger

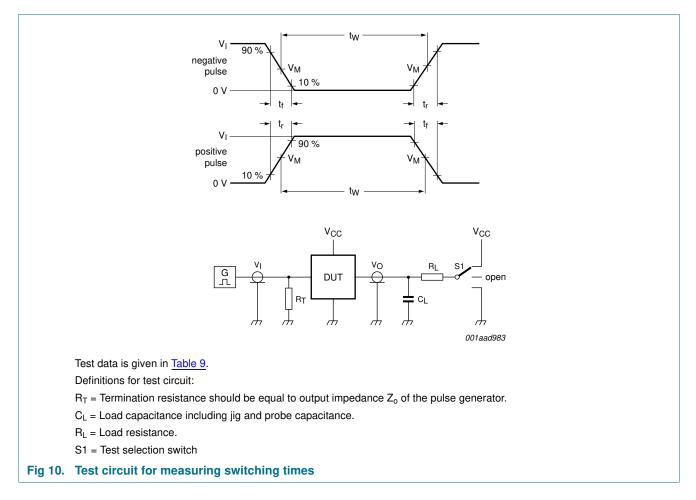


Table 9.Test data

Туре	Input		Load	S1 position	
	VI	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}
74HC273-Q100	V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open
74HCT273-Q100	3 V	6 ns	15 pF, 50 pF	1 kΩ	open

Octal D-type flip-flop with reset; positive-edge trigger

12. Package outline

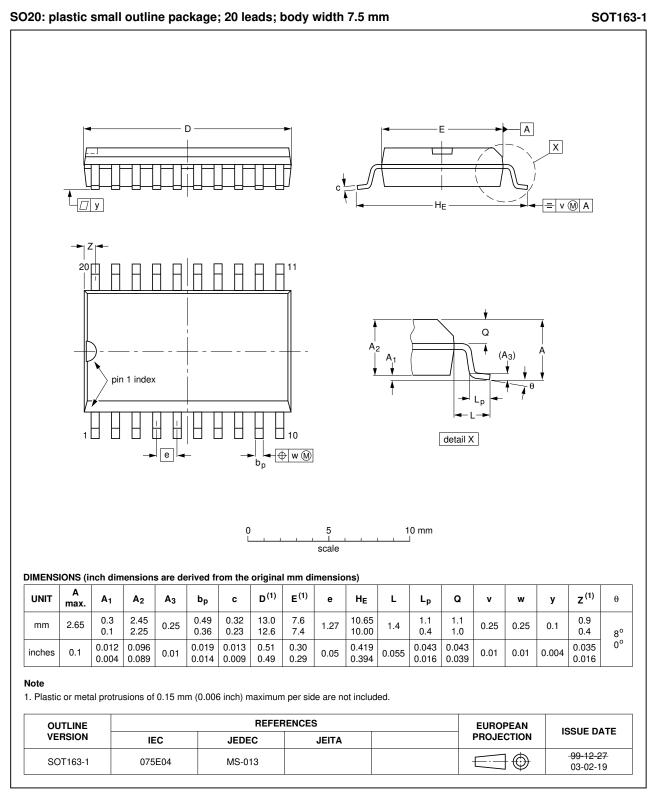


Fig 11. Package outline SOT163-1 (SO20)

All information provided in this document is subject to legal disclaimers.

74HC HCT273 Q100

Octal D-type flip-flop with reset; positive-edge trigger

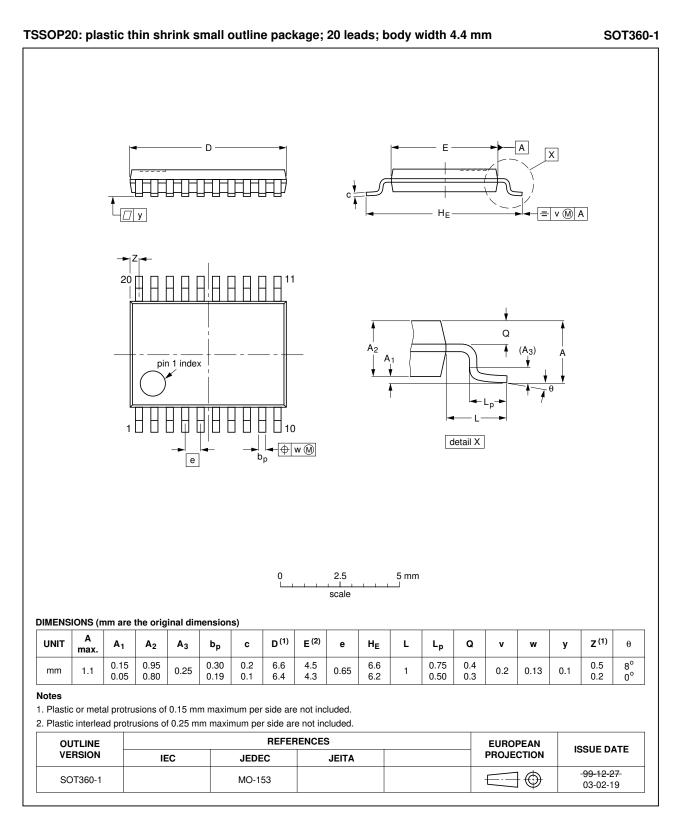
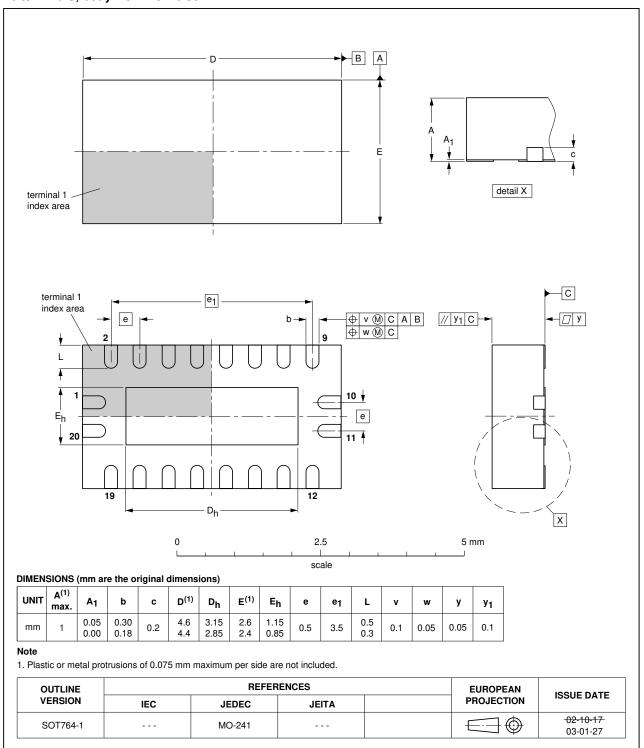


Fig 12. Package outline SOT360-1 (TSSOP20)

All information provided in this document is subject to legal disclaimers.

74HC_HCT273_Q100

Octal D-type flip-flop with reset; positive-edge trigger



DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 13. Package outline SOT764-1 (DHVQFN20)

All information provided in this document is subject to legal disclaimers.

74HC HCT273 Q100

Octal D-type flip-flop with reset; positive-edge trigger

13. Abbreviations

Table 10.	0. Abbreviations		
Acronym	Description		
CMOS	Complementary Metal-Oxide Semiconductor		
DUT	Device Under Test		
ESD	ElectroStatic Discharge		
HBM	Human Body Model		
MIL	Military		
MM	Machine Model		
TTL	Transistor-Transistor Logic		

14. Revision history

Table 11. Revision histor	Revision history						
Document ID	Release date	Data sheet status	Change notice	Supersedes			
74HC_HCT273_Q100 v.1	20130619	Product data sheet	-	-			

Octal D-type flip-flop with reset; positive-edge trigger

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

15.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

15.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use in automotive applications - This NXP

Semiconductors product has been qualified for use in automotive applications. Unless otherwise agreed in writing, the product is not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

Octal D-type flip-flop with reset; positive-edge trigger

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

15.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

16. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

Octal D-type flip-flop with reset; positive-edge trigger

17. Contents

1	General description 1
2	Features and benefits 1
3	Ordering information 1
4	Functional diagram 2
5	Pinning information 4
5.1	Pinning
5.2	Pin description 4
6	Functional description 5
7	Limiting values 5
8	Recommended operating conditions 6
9	Static characteristics 6
10	Dynamic characteristics 7
11	Waveforms 10
12	Package outline 13
13	Abbreviations 16
14	Revision history 16
15	Legal information
15.1	Data sheet status 17
15.2	Definitions 17
15.3	Disclaimers
15.4	Trademarks 18
16	Contact information 18
17	Contents 19

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2013.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 19 June 2013 Document identifier: 74HC_HCT273_Q100